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## **CRAFT® 25/25E**

FINE PITCH
SURFACE MOUNT
INSTALLATION/REPAIR
WORKSTATION

**OPERATION** 

MAINTENANCE

MANUAL

MANUAL NO. 5050-0219 REV. C

# **GENERAL INFORMATION**

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## CRAFT 25 GENERAL INFORMATION

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## **CRAFT 25 GENERAL INFORMATION**

#### INTRODUCTION

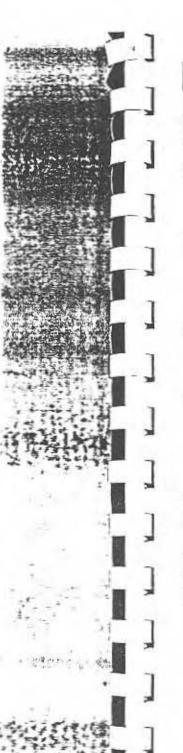
The CRAFT 25 represents a major new advancement in Surface Mount Technology (SMT) work stations. With its' advanced "Two-Head" system, the CRAFT 25 provides the best view of component leads and substrate lands for perfect alignment and placement of any type of component.

The the placement station, extended lead Surface Mount Devices (SMDs) are targeted and aligned with the precise X, Y, THETA controlled work platform aided by an unobstructed top view (using video camera, stereo microscope or lens) in which all four sides of the component are seen at once. After placement with the precise Z—axis controlled vacuum pick, the precision indexing table brings the work over to the reflow head where the component is perfectly aligned under the nozzle ready to be reflowed.

For PLCCs, LCCs and similar components, alignment and placement is best achieved with a 45 degree view from vertical of the leads and lands provided at the reflow head by a video camera or stereo microscope.

For component removal or installation, the CRAFT 25 provides total reflow process development and control. Utilizing either shop air, inert gas or the self-contained air blower, pressure/flow rate is easily controlled and maintained at optimum levels for the particular task at hand. Closed-loop, gas/air temperature control with digital "set" and "read" capability allows easy adjustment and repeatability of optimum reflow temperatures and (in conjunction with a selected flow rate) ramp-up rates. Reflow cycle time control, adjustable in one second increments, provides consistent, repeatable results in successive reflow operations.

Based on extensive thermal analyses in PACE's laboratories, the CRAFT Process Development Chart has been created to aid in the development of customized reflow processes for your particular SMD tasks.



## CRAFT 25 GENERAL INFORMATION

#### SPECIFICATIONS

#### POWER REQUIREMENTS:

CRAFT 25 (DOMESTIC VERSION)—115 VAC, 60 HZ, 12.8 AMPS, 1500 WATTS CRAFT 25E (EXPORT VERSION)—230 VAC, 50 HZ, 6.5 AMPS, 1500 WATTS

#### PHYSICAL PARAMETERS:

23" H × 20" W × 22" D (58 cm. H × 51 cm. W × 56 cm. D) WEIGHT—67 lbs. (30.4 kg.)

#### CIRCUIT BOARD CAPACITY:

STANDARD: 9" W × 18" L (23 cm. W × 46 cm. L)
WITH EXTENDED RAIL OPTION: 18" × 18" (46 cm. W × 46 L)

#### COMPONENT CAPACITY:

1.8" × 1.8" maximum (4.6 cm. × 4.6 cm.)

#### PRODUCT APPLICATION

The following sections of this manual will familiarize you with the parts and operation of the unit. This product is very versatile however, and may be used to satisfy a variety of application requirements. If you require assistance in the use of this product in your particular application, contact your local authorized PACE dealer or call PACE Applications Engineering at (301) 490-9860.

#### **AVAILABLE OPTIONS**

The options listed below are items which may be purchased to enhance the capabilities of the CRAFT 25 system. Each of the items listed are configured for easy connection to the CRAFT 25 unit using the instructions listed in this manual. See the "TABLE OF CONTENTS" for location of the instructions and part number listing of each option.

#### MICROSCOPE

- 1. 4X MICROSCOPE—(P/N 6018-0048) May be mounted on either Station I (Reflow Station) and/or Station 2 (Placement Station) for viewing of component and PCB land area, 4X power is obtained by using 10X eyepieces with a built in 0.4X objective lense (0.4 × 10X = 4X). Requires purchase of Reflow Head Microscope Mount when used on Reflow Station.
- REFLOW HEAD MICROSCOPE MOUNT—(P/N 6018-0049) Allows the 4X microscope to be mounted on Station 1 (Reflow side) of the CRAFT 25 unit. No mount is required for attachment to Station 2 (Placement side).

T G G G G

- 20X EYEPIECES—(P/N 1106-0033) Used on the 4X microscope to change the power to 8X (0.4X objective × 20X eyepieces = 8X).
- 4. 2.5X OBJECTIVE LENS KIT—(P/N 6018-0050) Screws onto microscope and focus mount. Increases magnification by 2.5 times (e.g. 2.5 × 4X = 10X) and repositions Microscope for proper focus.

#### LICHTING SYSTEM

- DUAL HALOGEN LIGHTING SYSTEM (P/N 7007-0011)—Provides a dual light source for use with video and/or microscope viewing systems. Can only be mounted to the CRAFT 25 system by using one of the mounts (video and/or microscope) listed above.
- POLARIZER KIT (P/N 6018-0058)—Used with lighting system and Video camera to minimize viewing glare.

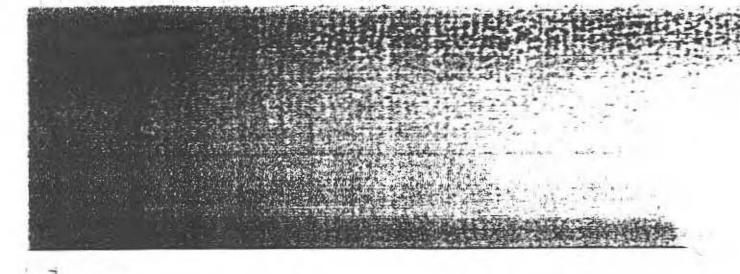
#### REMOTE CONTROL (P/N 6018-0047)

Allows the operator to remotely activate the CRAFT 25 heat cycle plus both Station 1 and Station 2 vacuum controls. The control may be placed at the operator's fingertips for greater convenience.

PREHEATING SYSTEM (P/N 8040-0001 (115 volt), 8040-0002 (220 volt))

#### HS-150/150E SYSTEM

A self-contained unit designed to provide auxiliary heat to the printed circuit board prior to and during removal or replacement of component(s). The unit may be set securely onto the CRAFT 25 work platform and is recommended to minimize thermal shock and to facilitate repair of multilayer or high power dissipation pc assemblies.



## AVAILABLE OPTIONS (Cont'd)

#### NOZZLES

- STANDARD NOZZLES—A selection of standard nozzles are available for use on the CRAFT 25 system and may be ordered using the Standard Nozzle Replacement Parts List shown on pages 50 thru 52 of this manual.
- CUSTOM NOZZLES—PACE can prepare special nozzle configurations to address any specific requirements not satisfied through the use of standard nozzles. Contact PACE directly at (301) 490-9860 (FAX # 301 498-3252) for assistance.

#### PCB CAPACITY ENHANCEMENT

- EXTENDED RAIL KIT—(P/N 6993-0126) The CRAFT 25 is equipped to allow for rework of PCB assemblies with physical dimensions of up to 12 inches by 18 inches (30.5 cm × 46 cm). Extra length rails may be ordered as options to allow for rework of PCB assemblies as large as 18 inches by 18 inches (46 cm × 46 cm).
- PCB TEMPLATE KIT—(P/N 6018-0064) Allows the user to support large PCB
  assemblies on the CRAFT 25 unit. Kit contains two board edge support rails with
  PCB tooling hole mounting capability and an adjustable center support.

#### SERVICE/MAINTENANCE

- Service/Maintenance Manual—(P/N 5050-0261) Will assist the technician in performing preventive maintenance, corrective maintenance and temperature calibration on the CRAFT 25 system.
- Alignment Kit—(P/N 6018-0053) Contains tools which allow the technician to easily check and adjust the alignment of the Reflow Head, Placement Pickup Assembly and Component Cubby with respect to each other.

#### VIDEO

PACE offers the following video mounting mechanisms as interfaces for attaching video cameras and monitors to the CRAFT 25 system.

- VIDEO MOUNT (Reflow stn.)—(P/N 6018-0072) Used to mount a video camera to the Reflow Station (at a 90° angle to the workpiece) for observation of the placement process.
- VIDEO MOUNT (Placement stn.)—(P/N 6018-0071) Used to mount a video camera
  to the Placement Station (at a 90° angle to the workpiece) for observation of the
  placement process.
- MONITOR MOUNT—(P/N 6018-0044) A universal type metal bracket which permits the selected video monitor to be directly mounted onto the top center of the

100 mg 117

#### **VIDEO SYSTEM**

Listed below is the Video system which PACE provides for use with the CRAFT 25 and is easily attached to the unit.

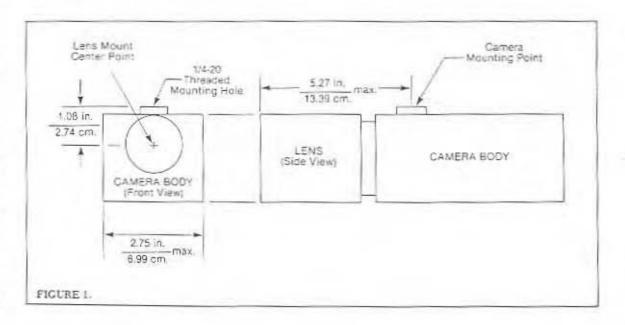
#### COLOR SYSTEM

QTY. REQ. COMP. SYSTEM	DESCRIPTION	PART NUMBER
2	Color Camera	1107-0013
1	Color Monitor	1107-0007
1	Power Supply	7008-0177
2	Camera Kit	6018-0065
	Complete Color System (Domestic)	6018-0054
	Complete Color System (Export)	6018-0056
	Complete Color System	
	(Export, Less Monitor)	6018-0061

#### VIDEO CAMERA REQUIREMENTS

The following guidelines must be followed if the user of a CRAFT 25 system wishes to purchase a video camera system other than those recommended by PACE. Use the illustration as a guide for each of the parameters.

- The lens mount of the Video Camera body must be centered 1.08 inches (2.74 cm.) from the camera mounting point.
- 2. The width of the Video Camera body must not exceed 2.75 inches (6.99 cm.).
- The length from the end of the lens to the center of the camera mounting point shall not exceed 5,27 inches (13.39 cm.).
- 4. The camera mounting point shall have a 1/4-20 tapped hole.
- The total combined weight of the camera and all attachments (including lights) must not exceed 4 lbs. (1.81 kg.).



BASE UNIT

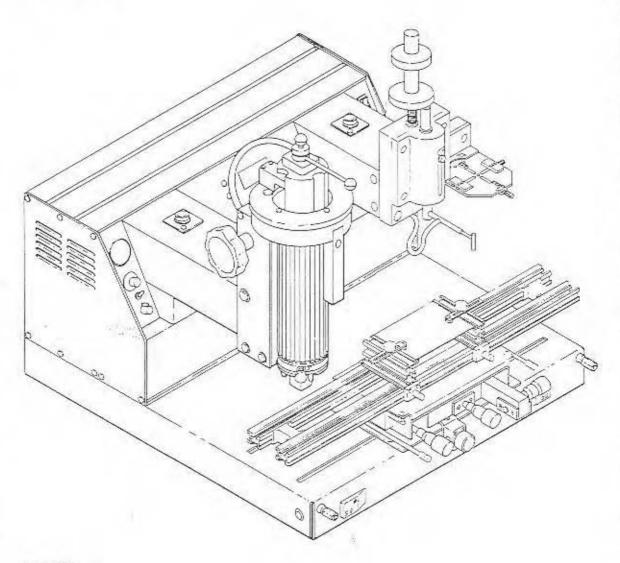
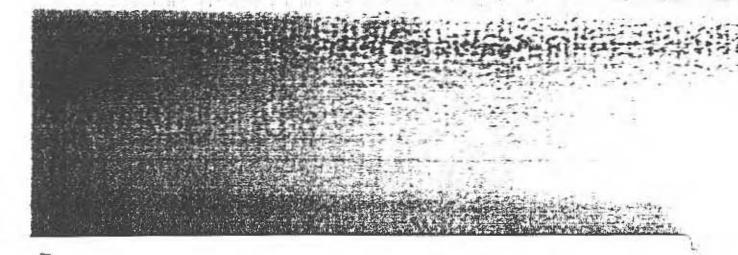


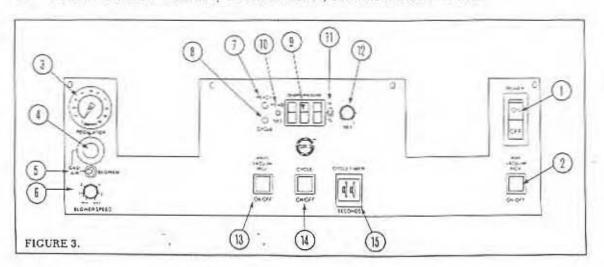
FIGURE 2.

10



### CONTROL PANEL

- 1. MAIN POWER SWITCH-Provides input power to unit.
- 2. AUXILIARY VACUUM SWITCH-Activates vacuum for station 2 pickup device.
- CAS/AIR PRESSURE GAUGE—Indicates air pressure level from compressed air or gas supply.
- GAS/AIR PRESSURE CONTROL—Allows regulation of compressed air or gas pressure flow.
- GAS/AIR BLOWER SWITCH—Allows selection of compressed air or internal blower supply to heater.
- BLOWER SPEED CONTROL—Allows control of blower speed to regulate air flow to heater in blower mode.
- READY LIGHT—Turns on when Heater achieves operating temperature and is ready for operation.
- CYCLE LIGHT—Turns on when heater is in reflow cycle.
- TEMPERATURE DISPLAY—Three segment display for heated air temperature readout. Temperature shown is air temperature at top of nozzle.
- READ/SET SWITCH—Allows temperature display to show set temperature level in set mode or actual temperature in read mode.
- °F/°C SWITCH—Provides either "F or °C readout on temperature display.
- SET CONTROL—Allows user to set operating temperature of heater.
- MAIN VACUUM PICK SWITCH—Push-push switch controls vacuum supply to station 1 pickup assembly.
- CYCLE SWITCH—Push switch starts air flow through heater initiating reflow cycle.
   Deactivates air flow when pushed during a reflow cycle.
- CYCLE TIMER—Manually resettable timer, controls duration of heat.

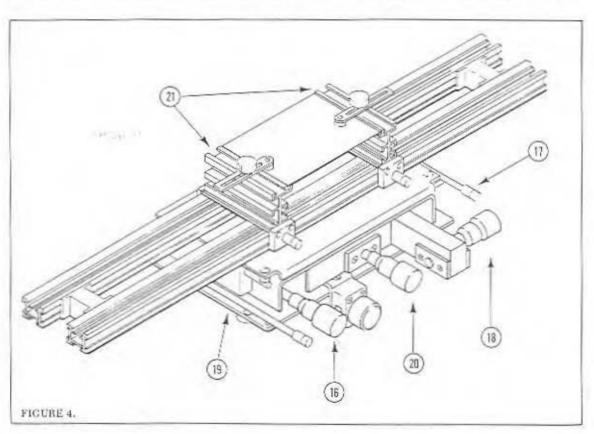


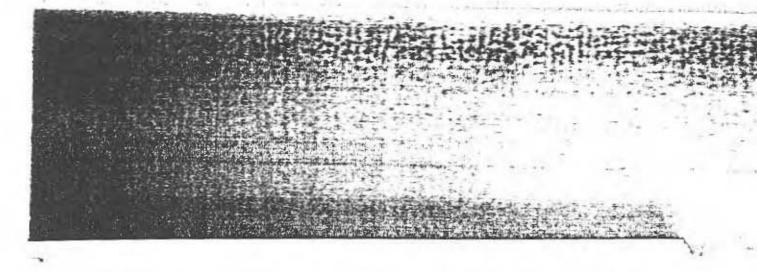
#### WORK PLATFORM

Provides an adjustable surface to clamp printed circuit board assemblies for rework.

 THETA ROTATION KNOB—Fine adjustment control which rotates platform about its center axis. L L

- COARSE X-AXIS ADJUSTMENT SLIDE—Allows clamped pcb assembly to be shifted side to side easily and locked into place.
- FINE X-AXIS ADJUSTMENT KNOB—Allows precision side to side movement of the work platform. Maximum travel of ±3/8 Inch from center position.
- COARSE Y-AXIS ADJUSTMENT SLIDE—Allows clamped pcb assembly to be shifted front to rear on the work platform and locked into place.
- FINE Y-AXIS ADJUSTMENT KNOB—Allows precision front to rear movement of the work platform. Maximum travel of ± 1/2 inch from center position.
- 21. CLAMP ASSEMBLY (2)-Locks printed circuit board assembly onto work platform.

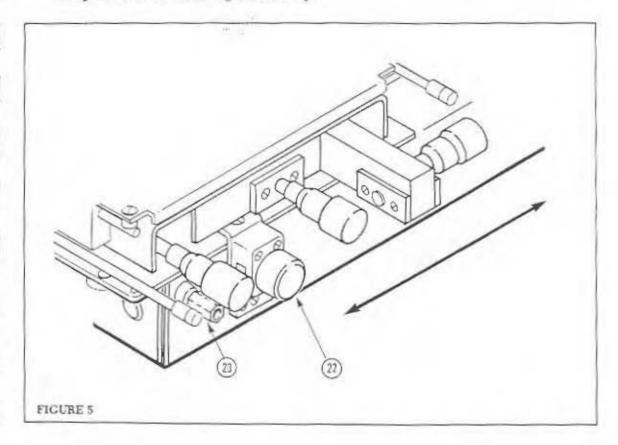




### INDEX ASSEMBLY

 INDEX KNOB—Allows work platform to be moved between station 1 and station 2 and locked into place.

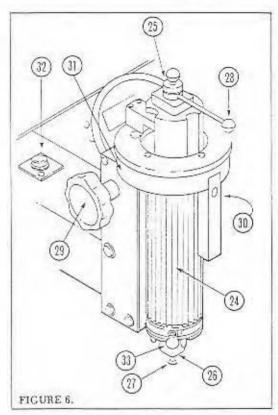
 EARTH GROUND TERMINALS—Provide grounding points for connecting the CRAFT 25 system to the work piece to prevent static charges from damaging sensitive components or for attaching a wrist strap.



## **REFLOW STATION (STATION 1)**

Station used for all PLCC and LCC repair functions plus component removal and reflow of all components.

- HEATER ASSEMBLY—Supplies heated air or gas (directed through air nozzle) to simultaneously reflow all solder joints.
- 25 VACUUM PICKUP ASSEMBLY—Provides a means to lift or place components from or onto PCB.
- NOZZLE ASSEMBLY—Directs heated air or inert gas from the heater assembly to the solder joint areas for either soldering or desoldering of components.
- VACUUM PICKUP CUP—Provides
  positive holding of components for positioning during the replacement process
  and for lifting of the component during
  the removal process.
- VACUUM PICK LOCKING LEVER— Locks the heater assembly and vacuum pickup assembly together for simultaneous movement and unlocks to allow independent movement.
- Z-AXIS CONTROL—Controls z movement (2 inch max.) of heater and vacuum pickup assemblies.
- NOZZLÉ CLÉARANCE LIMITER— Limits downward movement of heater assy. Prevents nozzle from contacting PCB.
- OPTICS ROTATION BEARING—Allows attached optic assemblies to be rotated in a 180° arc around the heater assembly for viewing of placement and reflow processes. Features position stops at 0° and ±90°.
- LIGHTING OUTPUT RECEPTACLE—Connects power from the CRAFT 25 system to the optional Dual Halogen Lighting system.
- NOZZLE RETENTION LEVER—Provides lock, release and Theta-Shear for Nozzle assembly.



## PLACEMENT STATION (STATION 2)

Station used for placement of all gull-wing and flat pack type devices.

 AUXILIARY VACUUM PICK ASSEMBLY—Provides a means to lift replacement component from component locating fixture and place on land pattern of the PCB undergoing repair.

35. Z-AXIS CONTROL WHEEL—Moves the vacuum pickup assembly in the Z direction

to precisely lower components onto the PCB land area.

36. ACCESSORY MOUNTING SHAFT—Provides a means for attaching video, lighting and microscope options onto station 2.

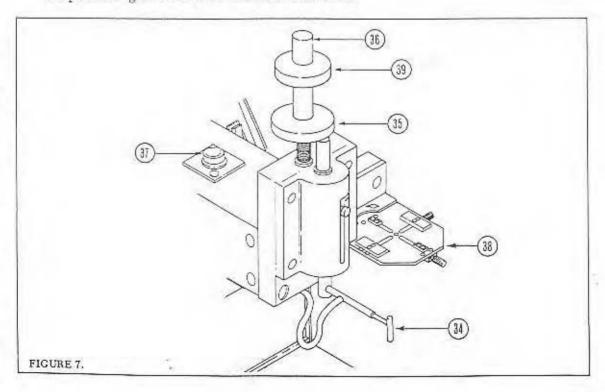
37. LIGHTING OUTPUT RECEPTACLE—Connects power from the CRAFT 25 system

to the optional Dual Halogen Lighting system.

COMPONENT LOCATING FIXTURE—Provides a method for holding a replacement component in proper position and orientation for pickup by the station 2 vacuum pickup assembly. Adjustable for components up to 2" × 2".

39. STOP COLLAR-Provides a resting surface for Video Mounts and includes a stop pin

for positioning of Video camera over rework area.



#### REAR PANEL

 AC POWER RECEPTACLE—Provides AC power to CRAFT 25 system from AC outlet through power cord.

41. LIGHTING POWER FUSE (F1)—Provides overload protection for Lighting power

supply.

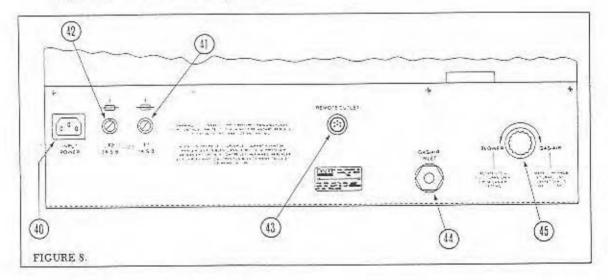
42. UNIT POWER FUSE (F2)-Provides overload protection for CRAFT 25 unit.

43. REMOTE OUTLET—An input for optional Remote Control activation of Cycle, Vacuum and Auxiliary Vacuum.

44. GAS/AIR INLET-Connector for attachment of compressed inert gas or filtered dry

air supply.

45. BLOWER SUPPLY CUT OFF CONTROL—Used in conjunction with GAS/BLOWER switch. Allows air to enter blower in the "Blower" position and seals the air intake when used in the "Gas/Air" position.



## OPTICS AND LIGHTING

46. STATION 1 OPTICS AND LIGHTING—Provides illumination and viewing of removal and placement functions. Views at an angle of 45 degrees to the pcb and swings on the mounting structure in an arc of 180 degrees which allows inspection of three sides of the component.

 STATION 2 OPTICS AND LIGHTING—Provides illumination and viewing of placement function for gull-wing and flat pack type components. Views at an angle of 90

degrees to the pcb displaying the entire component (including leads).

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Perform the following procedure step by step, in order, to obtain proper results. Use figure 2, page 10 as a guide.

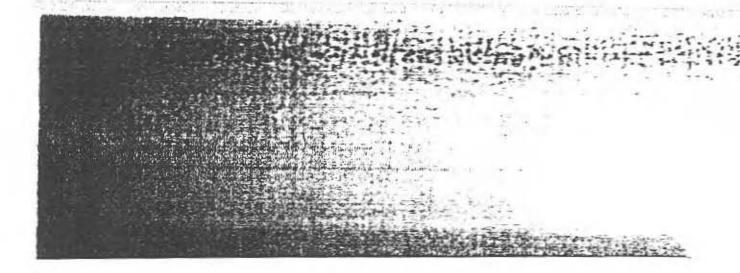
- Remove the CRAFT 25 system from its shipping container(s), including all options such as lights and video monitor). NOTE: DO NOT USE THE TWO MOUNTING ARMS (REFLOW AND PLACEMENT STATION) TO LIFE UNIT OUT OF SHIPPING CONTAINER.
- Set the CRAFT 25 unit onto a level work surface. Insure that power switch is n the "off" position.
- Install all purchased options (i.e. video cameras and lights) at this time. Refer to "TABLE OF CONTENTS" for location of applicable instructions.
- 4. Check the Work Platform for freedom of movement. If platform cannot be moved freely, adjust the four (4) feet underneath the unit base. Check the Station 1 Heater Assembly for freedom of travel. Check the Lock mechanism and Vacuum Pickup assembly.
- If the CRAFT 25 system is to be used with compressed air or gas, connect the supply line to the back of the unit.
- Place the Read/Set switch in the set position and turn the Heater Temperature Control fully counterclockwise.
- Insure that the Blower Supply Shutoff control (large black knob on rear of the unit) is turned fully clockwise when using the external air supply or fully counterclockwise when using the internal blower.
- 8. Plug power cable into AC supply.
- Turn power switch on and test system see "OPERATION", page 22.

#### INTRODUCTION

The CRAFT 25 systems provides the user with the ability to perform non-destructive, repeatable, high quality, installation or removal operations on Surface Mount PC assemblies. The operator can adjust the parameters of gas/air temperature, gas/air flow rate, cycle time, nozzle configuration and pre/auxiliary heating (using the PACE HotSpot unit) to suit the "heatability characteristics" of the particular component and substrate mounting site. The PACE Process Development System allows the operator to determine "starting point" parameters for his particular application based upon the particular component and substrate. Using these parameters and the Process Work Sheet, initial trial runs are conducted with successive corrections made based upon observed results. Once optimal results are obtained, the corresponding final process parameters for that particular component and substrate mounting site are entered on the Process Control Chart for future reference. A summary of the required Process Development sequence is listed below.

#### PROCESS DEVELOPMENT SEQUENCE

- 1. Use the Process Development Chart to determine Baseline parameters.
  - a) Select the component type and size which matches your application.
  - b) Select the substrate type that matches your application. Enter the indicated Preheat and Reflow Temperature Baseline Parameters onto the Process Work Sheet.
  - c) Locate the two vertical Air Flow columns at their point of intersection with the horizontal row of the selected component. Enter the indicated Air Pressure and Blower Speed parameters onto the Baseline Parameters section of the Process Work Sheet.
  - d) Locate the point of intersection between the Substrate and the Component rows. Enter the indicated Reflow Time parameter on line #1 of the Process Work Sheet.
- Enter the requested PC assembly and component designation onto the Process Work Sheet.
- 3. Complete the Baseline Time Parameter Computation section of the Process Work Sheet.
- 4. Complete the Process Testing section of the Process Work Sheet.
- Enter the Established Process Guidelines (as determined by the process testing) onto the Process Work Sheet.
- 6. Sign and date the Process Work Sheet.
- 7. Enter the Established Process Guidelines onto the Process Control Chart.



## PROCESS DEVELOPMENT CHART

CRAF	- Г бу		قاک		SUBSTRATE						
or Craft* R	EPONY OLA	190KY GLASS (FR-4)		CERANIC	POLY:MODE	PCB					
				(V)	3 rives	ž + Lzyer	FLEE	12000000	344.7/1042	MATERIAL	
CON	MPONEN	T	AIR F	LOW	sore	20"	siche	75*	1204	TEAN INC	
coursess Out All	COMPONENT - TVPE	OVSTALL SUS	ASSUME.	\$454E3	30"	25"	3104	430°	229	をはまれ	
Caructumen	P.C.	185 Tip 17 170 17 1000	35	Ма	15	ĸ	14-	ış	10		
	-12 Te330	Dier die dinen (2 x 17mm)	50	Max	20	12	20	16	12		
	ill Light	Less Than 5 + 5 Prot. 1/2 + 12 mil	25	Máx	20	14	16	20	22	***************************************	
		0ve 5+5 ror 112+10rm	59	u <sub>de</sub>	25	74	25	30	18		
	1,57	Lest Fran 4 e 4 hch 16 x 10mm	×	1	и	12	12	15	19		
	PACE	Quel 4 x 4 fects (10 x 10mm)	30	1	30	25	28.	34	15	W. E.	
	QLK2	Cess Tran Six Silecti 12 x 12mms	20	2	12	10	12	10	2	:58C )	
	7557	0vr 5 + 5 mm 117 + 12mm	30	Ŧ	n	-16	38	26	34		
<del></del>	56/I	153 mgs 13 5kms 500y	76	3	16	12	12	14	10		
	301	50 t Hange Outstell	25	1	12	10	10	10	1		

Use this chart to determine a base starting point for development of your surface mount rework process. Select the Component Quitine and Substrate which pep matches your approach. Enter the indicated settings and a CRAFT\* Photoss Wark Sheet. Copyright 1988 PACE, INC. Laure, Maryland At rights reserved. Printed in U.S.A.

#### PROCESS WORK SHEET

# CRAFT DAGE

Use this work sheet to develop your rework process. Enter the base line parameters determined from the Process Development Chart onto line 1 and "Base Line Parameters" on this form. Follow the subsequent instructions step by step to insure optimum results.

LP HazelliniA	1.0										
Component L	ocation or De	esignation:									Removal and rs. Increase cr
	Base l	ine Time P	arameter			decrease	Total Re	tlow Time	in 2 5	econd inc	rements until
1, Enter Reflo	ow Time para	meter_		-	580		ncrease 1	Total Reflor			ds for Removal
2. Add 2 sec	onds if fluxin	g is not allow	wed.	+	sec.			Proces	s Testing		
3. Add 2 sec is used.	conds II high	temperatu	re solder	+	sec.	Date	Refl	ow Time		Results	Initials
4. Subtract : is used.	2 seconds if	low temper	rature solder	+							
5. Total Rello	w Time Base	Line (add 1	1 thru 4)		sec.						
		Line Parar Process Deve	meters elopment Char	t)							
Preheat Temp.	Air Pressure	Blower Soeed	Reflow Temp.		Reflow (from 5)		Establ	ished Proc	ess Guid	elines	
ec		auceu	°C	THIRD I	sec.	Preneat Temp	Preneat Time	Air Pressure	Blower Speed	Reflow Temp	Total Reflow Time (from 5)
					300000	°C	580	osi		°C	sac

#### elines

Preneat	Preneat	Air	Blower	Retiow	Total Rellow
Temp	Time	Pressure	Speed	Temp	Time (from 5)
°c	580,	osi		°C	sec.

FIGURE 10.

PROCESS CONTROL CHART

CRAFT DAGE

SUBS	TRATE	COMPO	DNENT		HEAT	TING		AIRFLOW		SPECIAL	
esig- izter	Malerial	Design masion	Type	Prefeat Temp °C	Preheat Time (min)	Reflow Temp 40	Retiow Time	Air Pressure	Blower Speed	PROCEDURES	
PRO	DCESS ERIALS	FLUX	Name Type			Solder (or I	Pastej aterial			Diner:	

FIGURE 11.

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#### PREHEATING

Preheating of a printed circuit is normally required in the repair process whenever any one or more of the following situations exists.

- 1. Epoxy glass substrate with 4 or more layers.
- 2. Substrate with large ground planes.
- 3. Substrate of ceramic, polimide or other high heat dissipative material.
- 4. PC assembly with large metal heat sinks.

Preheating of assemblies such as those listed above will accomplish the following objectives.

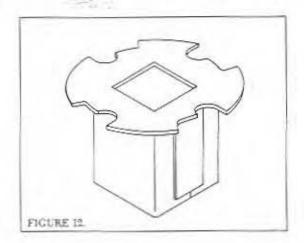
- Minimize thermal shock by elevating the assembly temperature to a level closer to solder melt.
- 2. Minimize the heat cycle reflow time.
- Overcome the heat dissipation characteristics of the assembly.
- Avoid adjacent melts on densely populated assemblies.

The assembly undergoing repair must be heated for a time sufficient to saturate at the temperature required. Preheat temperatures normally used are 85-95°C (185-203°F) for glass substrates and 120°C (248°F) for ceramics and polyimides.

Although many different methods such as ovens and heated plates may be utilized to accomplish the required results, the user must employ a method which heats the assembly as evenly as possible and can be employed on the CRAFT 25 unit. The preheat temperature should also be maintained throughout the Removal/Replacement process. PACE recommends the use of the HotSpot (HS-150/E) unit for this purpose.

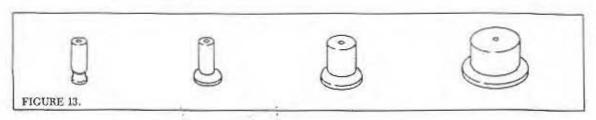
### NOZZLE SELECTION

Selection of the proper nozzle assembly is essential to the performance of a quality repair. Each nozzle assembly is designed to insure that heated air or gas is focused directly onto the PCB land area. Listed on pages 50-52 are commonly used nozzles and the components for which they are normally used. Select the nozzle (part number stamped on the nozzle flange) configured for the component to be replaced. Contact your local PACE authorized dealer or call PACE Applications Engineering at (301) 490-9860 for assistance.



## VACUUM CUP SELECTION

Selection of the proper size vacuum cup is important for achieving an adequate holding force for each component. The cup selected should be as large as can be used without exceeding the body size of the component. Vacuum cups are consummable items which deteriorate over a period of time and are available in four sizes which can be ordered using the part numbers listed on page 45.



## NOZZLE CHANGEOUT

#### REMOVAL

- With the Locking Lever in the locked position, raise the Heater Assembly to its' topmost position.
- Using the right hand, place the Nozzle Chip Tool under the Nozzle Assembly.

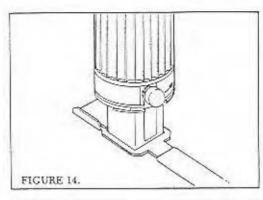
#### WARNING

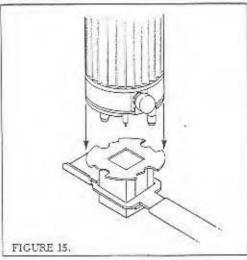
Never remove a heated nozzle with bare hands. Use the Nozzle Chip Tool.

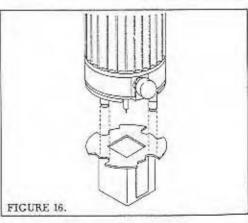
- With the left hand, move the Nozzle Retention Lever to the right. The Nozzle will be released from the Heater Assembly at this point.
- Hold the Nozzle on the Nozzle Chip Tool and set aside to cool.

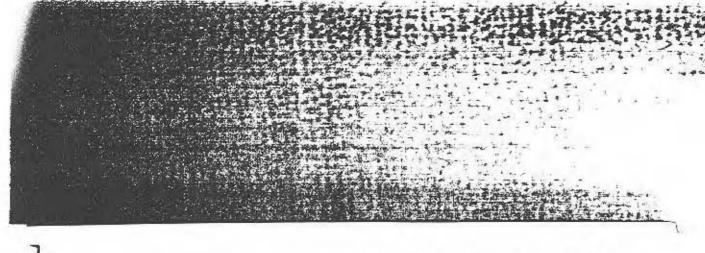
#### INSTALLATION

- Select the proper Nozzle for your application; see "NOZZLE SELECTION" page 23.
- If the Nozzle is rectangular in shape, orient the Nozzle for the most effective use with the assembly undergoing repair.
- Holding the Nozzle in the right hand, line up the four notches on the nozzle flange with the four Alignment Posts on the bottom of the Heater Assembly. See figure 26.
- Lift the Nozzle up over the four Alignment Posts and hold in place against the Heater Base.
- With the left hand, move the Nozzle Retention Lever to the left to secure the Nozzle.







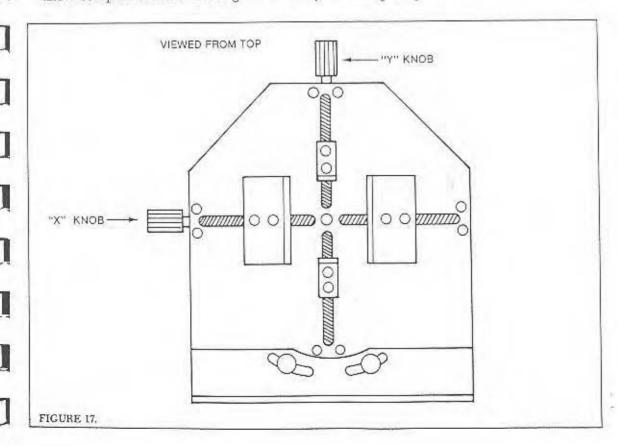


#### COMPONENT FIXTURE

The CRAFT 25 component fixture has been designed to accommodate component sizes of up to 2" × 2" (5.08 cm. × 5.08 cm.).

1. Using the "X" and the "Y" adjustment knobs, adjust the component fixture opening larger than necessary to accommodate the component.

 Place the component (properly oriented) into the component fixture.
 Using the "X" and "Y" adjustment knobs, adjust the component fixture to fit the component. Proper adjustment will minimize movement of the component in the fixture and allow component removal using the auxiliary vacuum pickup.



#### COMPONENT REMOVAL

1. Insert proper Nozzle Assembly and Vacuum Cup onto the reflow station.

Set controls listed below to optimize performance. If a written process has been developed, set controls as specified. If a process has not been developed, refer to PACE "Process Development Guidelines" page 18.

a) air pressure (or blower speed)

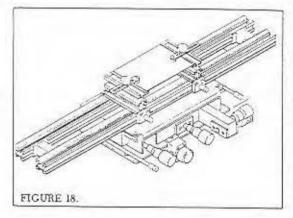
b) temperature (°C or °F)

c) cycle time

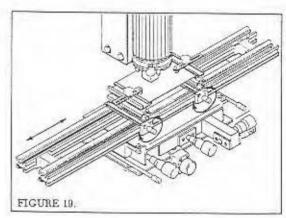
Raise Heater assembly to the topmost position.

4. Place PCB assembly onto Work Platform.

Apply flux (i.e. RMA flux) to the solder joints of the component to be removed.



6. With the Work Platform indexed under the reflow station, and the Slide Locking Lever in the unlocked position, adjust Work Platform to align component beneath Nozzle using the coarse "X" and "Y" adjustments. Lock Work Platform into place.

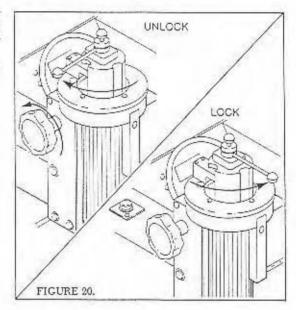


## COMPONENT REMOVAL (Cont'd)

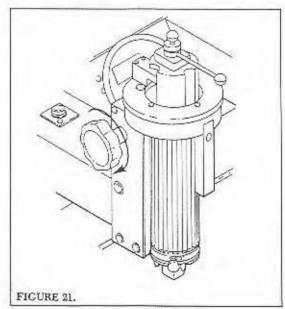
7. With the Vacuum Pickup Locking Lever in the unlocked position, raise the Heater
Assembly to a point at which the Vacuum
Cup extends below the Nozzle.

8. Move the Vacuum Pickup Locking Lever

to the locked position.



Lower the Heater Assembly until the Vacuum Cup contacts the component.

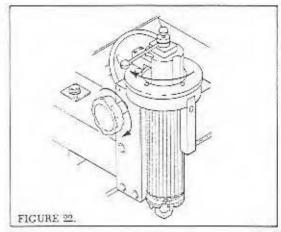


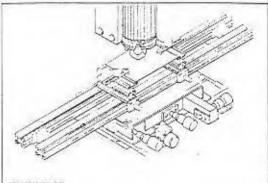
### COMPONENT REMOVAL (Cont'd)

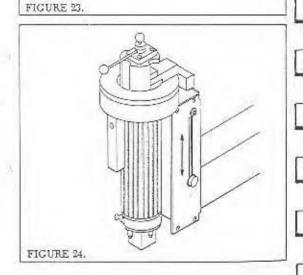
 Move the Vacuum Pickup Locking Lever to the unlocked position and lower the Heater Assembly (with Nozzle) over the component.

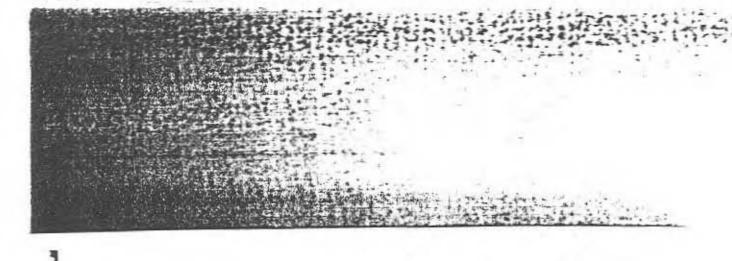
11. Readjust Work Platform using fine adjustment controls if Nozzle Assembly does not fit over the component. The component should be centered squarely in the Nozzle to insure uniform heating of the PCB land pattern during the reflow process.

- 12. Adjust Nozzle Clearance Limiter if necessary, to provide repeatable Nozzleto-PCB clearance. A clearance of .030-.050" is recommended. If vented nozzles are being used, clearance must be set to .000".
- 13. Activate Main Vacuum Pickup Switch.
- Push the Cycle Switch to start the heat cycle.
- Move the Vacuum Pickup Locking Lever to the locked position.



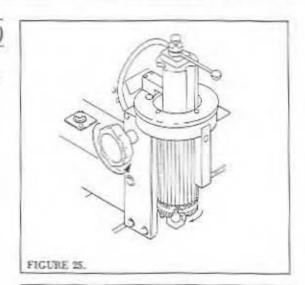






## COMPONENT REMOVAL (Cont'd)

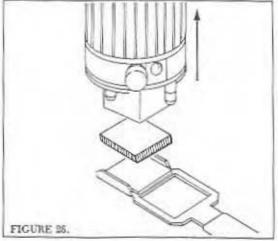
16. At the conclusion of the heat cycle, lift the Heater Assembly (with component) to the topmost position. NOTE: If the component being removed has been bonded to the substrate, move the Nozzle Retention Lever to the left before lifting the Heater Assembly. This provides a shearing action to break the bond.



 Place Nozzle Chip Tool under Nozzle and turn Main Vacuum Pick Switch off to release component.

#### WARNING

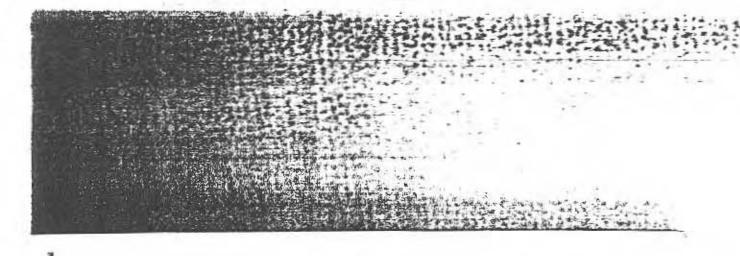
COMPONENT IS HOT! DO NOT retrieve component from Nozzle with hands or fingers, let component drop onto the Nozzle Chip Tool. Allow sufficient time for cooling.



#### BOARD/COMPONENT PREPARATION

Proper preparation is the key to successful soldering. To obtain good solder joints, use the following.

- 1. All component leads should be freshly tinned to insure solderability.
- Leadless ceramic chip carriers with gold plating should be pretinned. For quality work, check for correct solder deposition. The tinning process should not fill the castellations with solder.
- 3. Remove all flux applied during the component removal process.
- 4. Clean all component leads prior to soldering.
- 5. Remove all existing "old" solder from the PCB land pattern.
- 6. Do not touch component leads or PCB lands with bare fingers after cleaning.
- 7. Prepare the affected land pattern as per your specifications. For recommendations regarding processes which are best for your particular application, contact your local PACE dealer. The most widely used methods are as follows:
  - a) Pretinning—The PCB lands are pretinned using a soldering iron: taking precautions to insure that all lands are tinned with an equal deposition of solder. All lands must also be uniform in appearance.
  - b) Solder Paste—Apply an equal amount of paste to each land using a solder paste dispenser to control deposition. Take care to insure that the proper amount is dispensed. If too much paste is applied, bridging of lands will occur, whereas if a sufficient amount is not applied, solder joint formation will be unacceptable. The PCB assembly should also be preheated (in accordance with user's in-house requirements) after solder paste deposition to remove any solvents present in the paste. The PACE HotSpot (HS-150/150E) unit is highly recommended for this preheating application.
  - c) Solder Preforms—Any preforms must be designed specifically for each component used to insure proper solder deposition.



#### COMPONENT PRE-POSITIONING

The CRAFT 25 system is fully capable of accurately placing even very fine pitched components properly. In some instances however, the user may prefer to pre-position a component and hold it in place for soldering.

In order to properly position a component accurately, an optical aid (i.e. microscope) and glare free lighting should be used. Such accessories are available from PACE as either stand alone units or as options for the CRAFT 25 unit.

The following information and procedures will help you to obtain acceptable results.

#### TACK SOLDERING

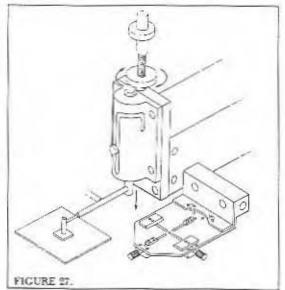
The following procedure can be useful when mounting leaded components.

 Pre-position the component leads to align with the land area using one of the following methods. NOTE: A flux paste may be applied to corners of the PCB land pattern to temporarily hold component in place.

a) Using the Station 2 Vacuum Pickup Assembly on the CRAFT 25 unit; follow the placement procedure described on pages 36 to 41 to place component on lands properly. Hold in place with the Z Axis Control Wheel, maintaining a slight downward pressure through the Vacuum Pickup Assembly, onto the component body.

 b) Using a pair of tweezers for handling and holding, pre-position the component leads to align with the land areas.

Using a micro-tipped soldering iron, tack two or more lead to land locations at opposite corners of the component. This will provide stability during subsequent handling throughout the soldering process.

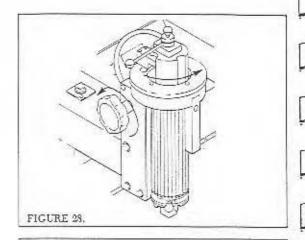


#### STAKING MATERIAL

- Apply a small amount of adhesive or other suitable staking material to underside of component. DO NOT USE A CYANOACRYLATE BASED ADHESIVE. WHEN SUCH MATERIALS ARE HEATED, CYANIDE GASES MAY BE EMITTED CREATING A HEALTH HAZARD.
- Pre-position component as in the "TACK SOLDERING" procedure shown above. The staking material will stabilize the component during subsequent handling and soldering. Solvent or water soluble material should be removed after the soldering process.

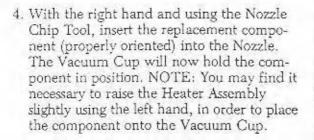
## COMPONENT REPLACEMENT (PLCC AND LCC ONLY)

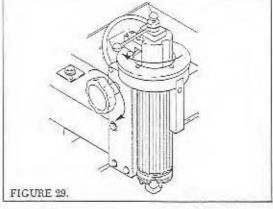
 Move the Vacuum Pickup Locking Lever to the locked position and raise the Heater Assembly to its' topmost position.

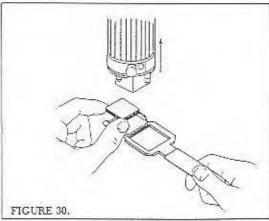


STEEL, 25 A R. (A.) "A R. C. (A.) TEEL CO. (A.) AR ST. C. (A.) TEEL CO. (A.)

- Move the Vacuum Pickup Locking Lever to the unlocked position and lower the Heater Assembly to a point at which the Nozzle Assembly extends below the Vacuum Cup.
- 3. Activate the Main Vacuum Pick Switch.

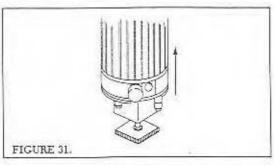




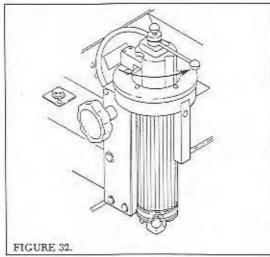


# COMPONENT REPLACEMENT (Cont'd) (PLCC AND LCC ONLY)

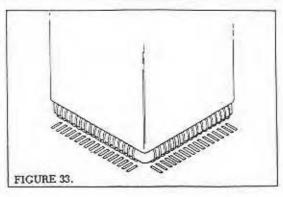
 Raise the Heater Assembly to expose the component.



Move the Vacuum Pickup Locking Lever to the locked position.

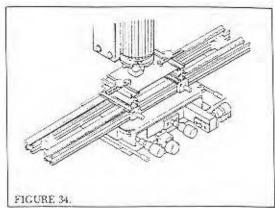


 Lower Heater Assembly to a point at which the component leads (or pads) rest just off the component land area on the PCB.

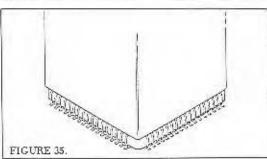


## COMPONENT REPLACEMENT (Cont'd) (PLCC AND LCC ONLY)

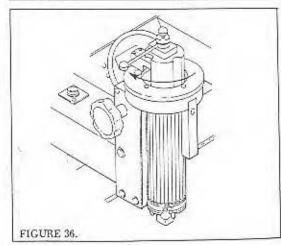
8. Adjust the fine controls on the Work Platform until the component leads (or pads) line up directly over the component land area on the PCB. Use of a video camera and monitor to view this is suggested. A camera mounted at a 45 degree angle to the PCB and swung in an arc of 180 degrees around the front of the component allows the operator to see three sides of the component to PCB alignment.



 Lower the Heat Assembly (with component) until the component leads rest lightly on the PCB land area.

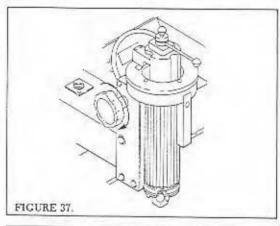


 Move the Vacuum Pickup Locking Lever to the unlocked position.

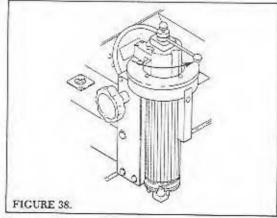


# COMPONENT REPLACEMENT (Cont'd) (PLCC AND LCC ONLY)

 Lower the Heater Assembly (with Nozzle) over component, Check to insure that the desired PCB to Nozzle clearance is maintained. Adjust Clearance Limiter if necessary.



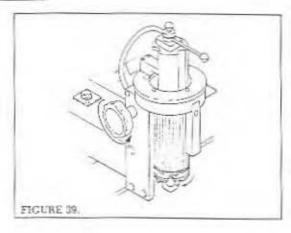
 Move the Vacuum Pickup Locking Lever to the locked position.



- 13. Recheck alignment of the component leads-to-land pattern.
- 14. Push Cycle Switch to activate heat cycle.
- 15. At conclusion of heat cycle, turn Main Vacuum Pickup Switch off. This will release the component and allow it to settle into the molten solder.
- Allow sufficient time for the solder to cool down and solidify. A time period of 20 seconds is sufficient in most cases.

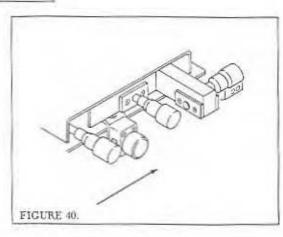
#### COMPONENT REPLACEMENT (Cont'd) (PLCC AND LCC ONLY)

 Raise the Heater Assembly to the topmost position.



#### COMPONENT REPLACEMENT (GULL-WING AND FLAT PACK DEVICES)

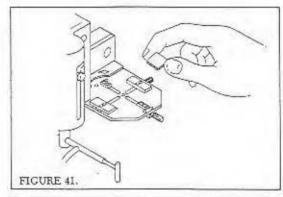
 Unlock the Index Assembly and move Work Platform to the right side of the CRAFT 25 unit until it locks in position.



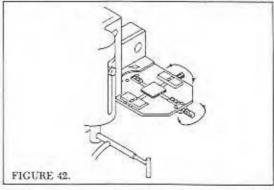
Insure that the PCB land pattern has been properly prepared (tinned and/or cleaned) and that RMA flux (or solder paste) has been applied.

# COMPONENT REPLACEMENT (Cont'd) (GULL-WING AND FLAT PACK DEVICES)

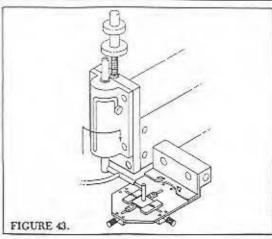
 Place the new component (properly oriented) into the Component Locating Fixture.



 Adjust the Component Locating Fixture to fit the component.

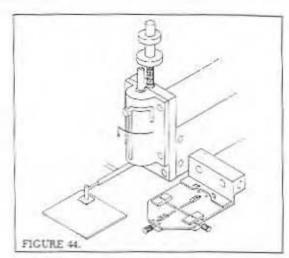


 Activate the Auxiliary Vacuum Pick Switch and Lower the Station 2 Vacuum Pickup Assembly onto the component.

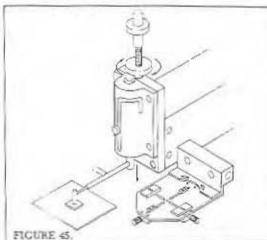


#### COMPONENT REPLACEMENT (Cont'd) (GULL-WING AND FLAT PACK DEVICES)

 Lift the Vacuum Pickup Assembly (with component) and position over the PCB land area. NOTE: If the component is large in size, it may be necessary to install the supplied metal vacuum cup onto the Vacuum Pick to provide additional holding force.

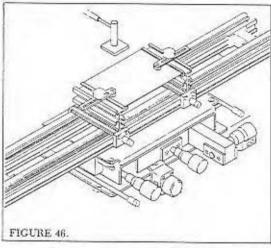


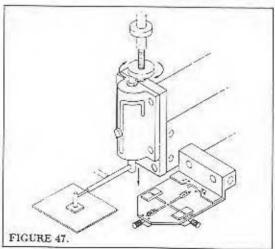
 Lower the Vacuum Pick Assembly by turning the Z Axis Control Wheel in a clockwise direction. Lower the assembly to a point where the component leads rest just above the land area.



# COMPONENT REPLACEMENT (Cont'd) (GULL-WING AND FLAT PACK DEVICES)

- 8. First adjust the Theta Rotation Knob until the component is square to the PCB land pattern and then the "X" and "Y" Fine Adjust Controls to align the component leads with the PCB land pattern. Viewing of this component-to-pattern alignment is enhanced by the use of a video camera and monitor system. The camera is mounted at an angle of 90 degrees to the PCB. This enables the opertor to view all four sides of the component simultaneously.
- Lower the component gently onto the PCB land pattern by turning the Z Axis Control Wheel as described in step 7.
- Push Auxiliary Vacuum Pick Switch to release component.



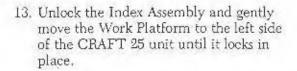


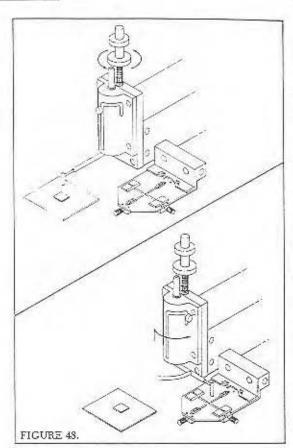
# COMPONENT REPLACEMENT (Cont'd) (GULL-WING AND FLAT PACK DEVICES)

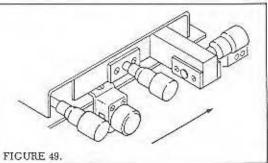
 Turn the Z Axis Control Wheel fully counterclockwise. Swing the Vacuum Pickup Assembly into position over the Component Locating Fixture.

12. Recheck component Lead-to-pattern alignment.

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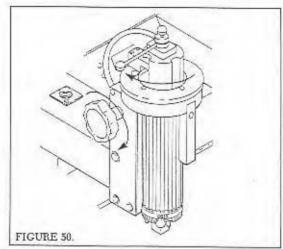




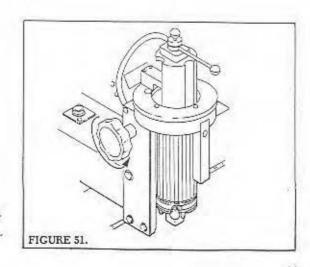


# COMPONENT REPLACEMENT (Cont'd) (GULL-WING AND FLAT PACK DEVICES)

- Recheck the component lead-to-land alignment.
- 15. With the Vacuum Pickup Locking Lever in the unlocked position, lower the Heater Assembly (with Nozzle) over component. Insure that the Nozzle fits properly around the component.



- 16. Push the Cycle Switch to activate heat cycle.
- 17. Allow sufficient time at the conclusion of the heat cycle for the solder to cool down and solidify. A time period of twenty seconds is adequate in most cases.
- Raise Heater Assembly to the topmost position.
- Inspect solder joints and component leadto-pad alignment.



#### CORRECTIVE MAINTENANCE

#### TABLE 1

When a problem in operation occurs, select the "Symptom" which applies and follow the steps given in the "Solution" column.

SYMPTOM	POSSIBLE CAUSE	SOLUTION
NO POWER—	Circuit breaker tripped.	Reset Main Power Switch.
	Line cord unplugged.	Plug Line Cord into outlet.
	AC supply circuit breaker tripped.	Reduce # of other devices on circuit.
NO TEMPERATURE DISPLAY—	Blown fuse F1	Replace fuse.
NO LIGHTS—	Blown fuse F2	Replace fuse.
NO VACUUM—	Dirty filter(s)	Replace Visi Filter(s).
	Kinked or broken vacuum line.	Repair or replace vacuum line.
UNIT DOES NOT CYCLE— Display reads "888".	Over-temperature cutoff circuit has activated.	Check Blower Supply Cutofi Control and Gas/Blower Switch settings.
	Shorted Airstream Thermocouple.	Contact Pace Customer Service.
READY LED DOES NOT LIGHT— Read temperature is at or near room temperature.	Defective Heater Assembly.	Contact Pace Customer Service.
READ TEMPERATURE DOES— NOT REACH SET TEMPER- ATURE.	Air flow obstructed,	Check Blower Supply     Cutoff Control and Gas/     Blower Switch settings.     Check for kinked, or     broken air flow tube in unit.
	Defective Airstream Thermocouple,	Contact Pace Customer Service.

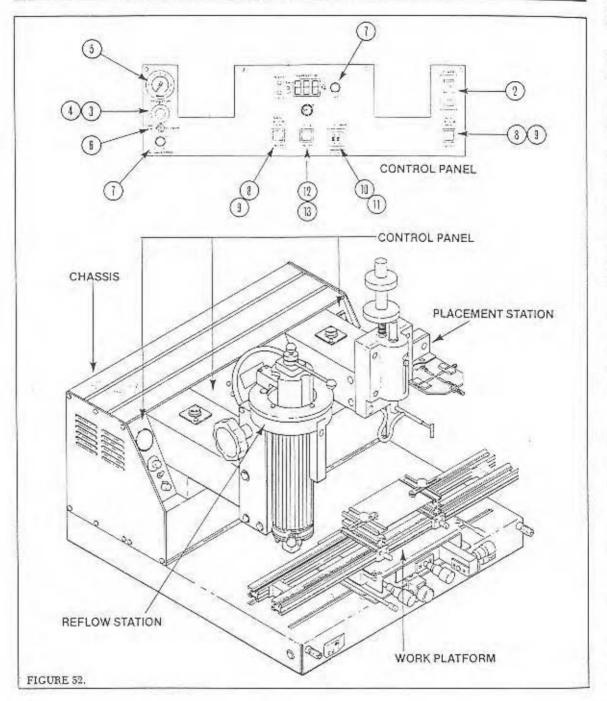
When ordering replacement parts for your CRAFT 25 system, find the system area where the part is located on page 46. Refer to the system area illustrations to locate the replacement part and its item number. Using the item number, refer to table 2 for the description and PACE part number.

#### CRAFT 25 UNIT

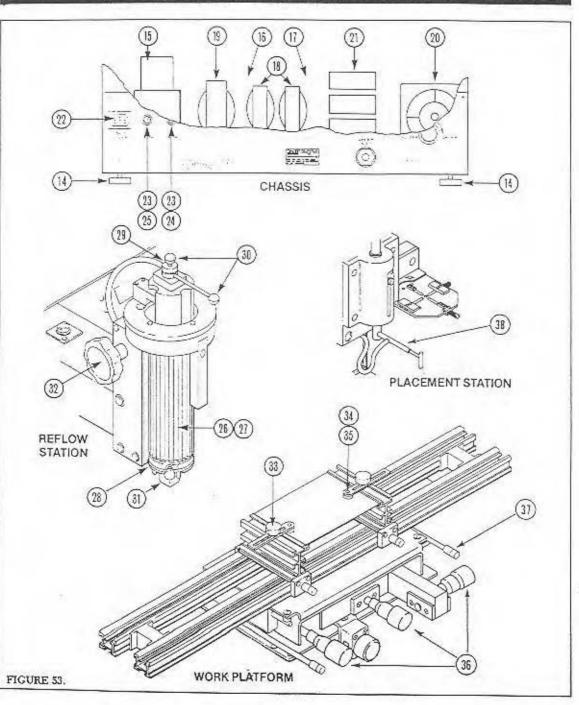
ITEM #	QTY.	PART NO.	DESCRIPTION	SUBASSEMBLY AREA
1	1	7018-0036 7018-0037	CRAFT 25, Domestic (115V) CRAFT 25, Export (230V)	Unit Unit
2	1	1157-0063	Power Switch, 115V CRAFT 25	Control Panel
	1	1157-0059	Power Switch, 230V CRAFT 25E	
3	1	1263-0030	Gas/Air Regulator	
	1	1222-0033	Gas/Air Pressure Knob	
4 5 6 7 8 9	1	1108-0005	Cas/Air Pressure Gauge	
6	1	1157-0060	Toggle Switch	
7	2 2 2	1222-0049	Control Knob, Temp. & Blower	
8	2	1157-0061	Vacuum Switch, Lighted	
9	2	1171-0007	White Cap, Vacuum Switch	
10	2	1157-0064-01	Cycle Timer Switch	
11	1	1157-0064-02	End Plate, Cycle Timer Switch	
12	1	1157-0062	Cycle Switch	
13	1	1171-0008	Green Cap, Cycle Switch	
14	4	1274-0032	Leveler Pad, Rubber	Chassis
15	1	1336-0026	Motor Pump Assembly	
16	1	6020-0054	Main PCB Assembly	
17	1	6020-0055	Display PCB Assembly	
18	2	1192-0057	Transformer, Lighting	
19	1	1192-0059	Transformer, Power	
20	1	6008-0119	Blower Assembly	
21	3	1194-0016	Solenoid	
22	1	1207-0204	AC Power Receptacle	
23	2	1161-0008	Fuse Holder	
24	1	1159-0246	Fuse, F1, 1 AMP S.B. (Domestic)	
		1159-0213	.5 AMP S.B. (Export)	
25	1	1159-0247	Fuse, F2, 2 AMP S.B. (Domestic)	
1000	83	1159-0216	1 AMP S.B. (Export)	

# CRAFT 25 UNIT (Cont'd)

7	ITEM #	QTY.	PART NO.	DESCRIPTION	SUBASSEMBLY AREA
_1	26	1	4010-0091	Heater Core, CRAFT 25 (115 V)	Reflow Stn.
	28	1	4010-0092	Heater Core, CRAFT 25E (230 V)	
-7	27	1	4010-0093	Heater Tube Assembly	
4	28	î	4010-0094	Reflow Sensor	
	29	1	4010-0095	Vacuum Pick Assembly	
- 72	30	2	1222-0061	Vacuum Pick Control Knob	
- 1	31	2	1222-0062	Nozzle Locking Lever Knob	
-	32	1	1222-0053	Z Axis Control Knob	
7	33	2	1222-0044	Clamp Locking Knob	Work Platform
	34	2	1209-0030	PCB Holder Arm	
	35	2 2	1274-0033	Bumper, PCB Holder Arm	
- 75	36	3	1222-0076	Fine Adjust Knob (X,Y, Theta)	
	37	4	1222-0074	Rail Locking Knob	
	38	1	4018-0043	Vacuum Pickup Assembly	Placement Stn.
-7	39	1	1213-0045-P5	Vacuum Pickup Cup	1 CHEST - CHOICE STORE STORES
	40	1	1332-0134	Power Cord, Domestic (115V)	Misc. Access.
200	41	1	1332-0135	Power Cord, Export (230V)	
1	42	1	1100-0231	Nozzle/Chip Tool	
	43	1	1165-0023	Lamp, 120 V, 20 W	
-	44	1	1309-0020	VisiFilter	
-1	45	1	1121-0280-P2	Vacuum Cup, .625 Dia.	Consummables
150	46	1	1121-0281-P2	Vacuum Cup, 400 Dia	ASSESSMENT OF THE PARTY OF THE
	47	1	1121-0282-P2	Vacuum Cup, .312 Dia.	
-1	48	1	1121-0288-P2	Vacuum Cup, .200 Dia.	
	49	1	5050-0219	Operation Manual	
	50	1	5050-0261	Service Manual	



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## ACCESSORIES

ITEM NO.	DESCRIPTION	PACE PART NO.
1.	Color Video System	
-	Domestic	6018-0054
	Export	6018-0056
	Export Less Monitor	6018-0061
2.	Reflow Station Video Mount	6018-0072
3.	Placement Station Video Mount	6018-0071
	Monitor Mount	6018-0044
4. 5.	4X Microscope	6018-0048
6.	20X Eyepieces	1106-0033
7. 8. 9.	Reflow Station Microscope Mount	6018-0049
8.	Placement Scope Assembly, 2.5 Objective	6018-0050
9.	Dual Halogen Lighting System	7007-0011
10.	Alignment Tool Kit	6018-0053
11.	Remote Control	6018-0047
12.	30" Work Holder Rail Kit	6993-0126
13.	PCB Template Kit	6018-0064
14.	Polarizer Kit	6018-0058

#### NOZZLES

Nozzle configuration plays a critical role in the CRAFT 25 SMD reflow process. A standard range of nozzles are available in Standard (Open-Wall), HV (Fixed Gap) and Vented nozzle design. A brief description of each nozzle type is given below.

- STANDARD OPEN-WALL—Directs heated gas/air flow at the component lead attachment area while minimizing flow over the component body. Especially useful in an R&D environment since the nozzle can be used to reflow different components of similar size and configuration. This nozzle type is also recommended for reflow of all Extended Lead devices (SOIC's, Flat Packs etc.).
- HV, FIXED GAP—Recommended for repeated reflow processes. Precision inserts matching the shape and dimensions of the component body holds the device centered within the nozzle facilitating alignment and placement.
- 3. VENTED—In some applications, high-density packaging of SMD assemblies has raised concerns regarding overheating of adjacent component solder joints leading to solder crystallization and eventual joint failure. The Vented nozzle walls seal off the component and vents the heated air/gas above the component thereby lowering adjacent temperature levels.

When ordering Nozzles for use with the CRAFT 25 system, refer to tables 4 thru 8. PACE can prepare additional special nozzle configurations to address any specific requirements not satisfied through the use of the nozzles listed. Contact PACE inc. directly at (301) 490-9860 (FAX. # 301 498-3252) for assistance.

## STANDARD NOZZLES

TA	Bl	LE:	

COMPONENT APPLICATION	COMPONENT SIZE (MAX.) INCHES	PACE PART NUMBER
PLCC-18	.467× .327	4018-0033-001
20	$.395 \times .395$	-002
28	.495× .495	-003
32	.595× .495	-004
44	.695× .695	-005
52	.795× .795	-006
68	.995× .995	-007
84	$1.195 \times 1.195$	-008
SO- 8	.244× .197	4018-0034-001
14	$.344 \times .244$	-002
16	$.394 \times .244$	-003
SOL-16	.419× .413	-004
20	.512× .419	-005
24	.612× .419	-006
28	.712× -419	-007
FLAT PACK-	*** <del>****</del>	4018-1036-001
58 LEAD	.989× .752	(With Locating Plate)

## STANDARD HV NOZZLES

#### TABLE 5

NT: THE TANK OF BUILDING AND A STATE OF THE PARTY OF THE				PACE PART NUMBER
PLCC-18	.467× .327	4018-0037-001		
20	.395× .395	-002		
28	.495× .495	-003		
32	.595 × .495	-004		
44	.695× .695	-005		
52	.795× .795	-006		
68	.995× .995	-007		
84	$1.195 \times 1.195$	-008		

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## VENTED NOZZLES

TABLE			
NT ON	COMPONENT SIZE (MAX.) INCHES	PACE PART NUMBER	
	.467 × .327	4018-0053-001	
	.395 × .395	-002	
	.495× .495	-003	
	.595× .495	-004	
	.695 × .695	-005	
	.795 × .795	-006	
	.995× .995	-007	
	$1.195 \times 1.195$	-008	
	.244× 197	4018-0054-001	
	.344 × .244	-002	
	$.394 \times244$	-003	
	.419 × .413	-004	
	.512× .419	-005	
	.612× .419	-006	
E-141	.712× .419	-007	
31 10	.308× .308	4018-0055-001	
	.435× .300	-002	
	.358 × .358	-003	
	.410 × .410	-004	
	.458 × .458	-005	
	.660 × .660	-006	
	.761 × .761	-007	
	.962 × .962	-008	
	$1.165 \times 1.165$	-009	